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LM2941QML 1A Low Dropout Adjustable Regulator

Check for Samples: LM2941QML, LM2941QML-SP

FEATURES

- Available with Radiation Ensure
 - ELDRS Free 100 krad(Si)
- Output Voltage Adjustable from 5V to 20V
- Dropout Voltage Typically 0.5V at $I_0 = 1A$
- **Output Current in Excess of 1A**
- **Trimmed Reference Voltage**
- **Reverse Battery Protection**
- Internal Short Circuit Current Limit
- **Mirror Image Insertion Protection**
- TTL, CMOS Compatible ON/OFF Switch

DESCRIPTION

The LM2941 positive voltage regulator features the ability to source 1A of output current with a typical dropout voltage of 0.5V and a maximum of 1V over the entire temperature range. Furthermore, a quiescent current reduction circuit has been included which reduces the ground pin current when the differential between the input voltage and the output voltage exceeds approximately 3V. The quiescent current with 1A of output current and an input-output differential of 5V is therefore only 30mA. Higher quiescent currents only exist when the regulator is in the dropout mode ($V_1 - V_0 \le 3V$).

Originally designed for vehicular applications, the LM2941 and all regulated circuitry are protected from reverse battery installations or two-battery jumps. During line transients, such as load dump when the input voltage can momentarily exceed the specified maximum operating voltage, the regulator will automatically shut down to protect both the internal circuits and the load. Familiar regulator features such as short circuit and thermal overload protection are also provided.

Connection Diagram

		-		
NC -	1	\mathbf{O}	16	
NC —	2		15	- NC
	3		14	— N/C
ADJ 🗕	4		13	– N/C
GND 🗕	5		12	- GND
NC —	6		11	- GND
NC —	7		10	– NC
NC —	8		9	- ON/OFF

Top View

Figure 1. 16-Lead CFP Package



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ISTRUMENTS

EXAS

Equivalent Schematic Diagram





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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Absolute Maximum Ratings⁽¹⁾

	nysv				
Input Voltage (Survival Voltage, ≤	100ms)		60V		
Internal Power Dissipation ⁽²⁾	nternal Power Dissipation ⁽²⁾				
Maximum Junction Temperature			150°C		
Storage Temperature Range			−65°C ≤ T _J ≤ +150°C		
Lead Temperature (Soldering, 10	seconds)		300°C		
		CFP "WG" (device 01, 02) (Still Air)	122°C/W		
	0	CFP "WG" (device 01, 02) (500LF/Min Air Flow)	77°C/W		
	OJA	CFP "GW" (device 03, 04) (Still Air)	136°C/W		
Thermal Resistance		CFP "GW" (device 03, 04) (500LF/Min Air Flow)	87°C/W		
	0	CFP "WG" (device 01, 02) ⁽³⁾	5°C/W		
	PJC	CFP "GW" (device 03, 04)	13°C/W		
		CFP "WG" (device 01, 02)	360mg		
Package weight (Typ)		CFP "GW" (device 03, 04)	410mg		
ESD susceptibility to be determine	ed ⁽⁴⁾		500V		

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For specified specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

(2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.

(3) The package material for these devices allows much improved heat transfer over our standard ceramic packages. In order to take full advantage of this improved heat transfer, heat sinking must be provided between the package base (directly beneath the die), and either metal traces on, or thermal vias through, the printed circuit board. Without this additional heat sinking, device power dissipation must be calculated using θ_{JA} , rather than θ_{JC} , thermal resistance. It must not be assumed that the device leads will provide substantial heat transfer out of the package, since the thermal resistance of the lead frame material is very poor, relative to the material of the package base. The stated θ_{JC} thermal resistance is for the package material only, and does not account for the additional thermal resistance and must combine this with the stated value for the package, to calculate the total allowed power dissipation for the device.

(4) Human body model, 1.5 k Ω in series with 100 pF.

Recommended Operating Conditions

Maximum Input Voltage	26V
Temperature Range	−55°C ≤ T _A ≤ 125°C



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Table 1. Quality Conformance Inspection Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55
12	Settling time at	+25
13	Settling time at	+125
14	Settling time at	-55

LM2941 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. DC: $5V \le V_0 \le 20V$, $V_{IN} = V_0 + 5V$, $C_0 = 22\mu F$

Parameter		Test Conditions	Notes	Min	Max	Unit	Sub- groups
V _{Ref}	Poforonoo Voltogo	$Fm \land < \downarrow < 1 \land$		1.237	1.313	V	1
	Reference voltage	$SIIIA \le I_0 \le IA$		1.211	1.339	V	2, 3
V _{RLine}	Line Regulation	$V_{O} + 2V \le V_{IN} \le 26V, I_{O} = 5mA$	See ⁽¹⁾		10	mV/V	1, 2, 3
VRef Reference VRLine Line F VRLoad Load IQ Quies VDO Dropoon ISC Short Maxim VOItage Revert VTH ON ON/O VTh Off ON/O	Load Regulation	$50\text{mA} \le I_{O} \le 1\text{A}, V_{IN} = 10\text{V}, V_{OUT} = 5\text{V}$	Sec. ⁽¹⁾		10	mV/V	1, 2, 3
		$\begin{array}{l} 50\text{mA} \leq \text{I}_{\text{O}} \leq 1\text{A}, \ \text{V}_{\text{IN}} = 25\text{V}, \\ \text{V}_{\text{OUT}} = 20\text{V} \end{array}$	See		10	mV/V	1, 2, 3
		1/1 + 21/5 + 526 + 1 = 5mA			15	mA	1
IQ	Quiescent Current	$v_0 + 2v \le v_{IN} \le 20v, v_0 = 511A$			20	mA	2, 3
		(1 - 1) + 5(1 - 1)			45	mA	1
		$v_{\rm IN} = v_{\rm O} + 5v, v_{\rm O} = 1A$			60	mA	2, 3
		1 - 10			0.8	V	1
Vac	Dropout Voltago	10 = 1A			1.0	V	2, 3
v do	Diopour voltage	$L_{2} = 100 m \Lambda$			200	mV	1
		10 = 10011A			300	mV	2, 3
le e	Short Circuit Current	V		1.6	3.5	А	1
ISC	Short Circuit Current	VIN Max = 20V		1.3	3.7	А	2, 3
	Maximum Operational Input Voltage		See ⁽²⁾		26	V_{DC}	1, 2, 3
	Reverse Polarity DC Input Voltage	$R_0 = 100\Omega, V_0 \ge -0.6V$	See ⁽³⁾	-15		V	1, 2, 3
V _{TH On}	ON/OFF Threshold Voltage ON	I _O ≤ 1A	See ⁽³⁾		0.8	V	1, 2, 3
V _{Th Off}	ON/OFF Threshold Voltage OFF	I _O ≤ 1A	See ⁽³⁾	2.00		V	1, 2, 3
		-201/1 < 10			100	μA	1
		$v_{ON/OFF} = 2.0v, I_O \leq IA$			300	μA	2, 3



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LM2941 Electrical Characteristics AC Parameters

The following conditions apply, unless otherwise specified.

AC: $5V \le V_0 \le 20V$, $V_{IN} = V_0 + 5V$, $C_0 = 22\mu F$

	Parameter	Test Conditions	Notes	Min	Max	Unit	Sub- groups
	Maximum Line Transient	$V_{O Max}$ 1V above nominal V_{O} , R_{O} = 100 Ω , t ≤ 100mS		60		V	4, 5, 6
	Reverse Polarity Transient Input Voltage	t ≤ 100mS, R _O = 100Ω		-50		V	4, 5, 6
חח	Binnla Dejection	$f_{\rm O}$ = 1KHz, 1 V _{RMS} , I _L = 100mA	See ⁽¹⁾		0.02	%/V	4
ĸĸ	Ripple Rejection	$f_{\rm O}$ = 1KHz, 1 V _{RMS} , I _L = 100mA	See ⁽¹⁾		0.04	%/V	5, 6

(1) %/V = % of V_{IN} per Volt of V_O .

LM2941 Electrical Characteristics DC Drift Parameters

The following conditions apply, unless otherwise specified. DC: 5V \leq V_O \leq 20V, V_{IN} = V_O+5V, C_O = 22µF Delta calculations performed on QMLV devices at group B , subgroup 5.

	Parameter	Test Conditions	Notes	Min	Max	Unit	Sub- groups
V _{Ref}	Reference Voltage	5mA ≤ I _O ≤ 1A		-25	+25	mV	1

INPUT-OUTPUT DIFFERENTIAL (V)

OUTPUT VOLTAGE

QUIESCENT CURRENT (mA)



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NSTRUMENTS

Texas

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EQUIVALENT SERIES RESISTANCE (Ω)

OUTPUT VOLTAGE (V)



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Typical Applications



 $V_{OUT} = \text{Reference voltage} \times \frac{\text{R1} + \text{R2}}{\text{R1}} \text{ where } V_{\text{REF}} = 1.275 \text{ typical}$

Solving for R2: R2 = R1 $\left(\frac{V_O}{V_{REF}} - 1\right)$

Note: Using $1K\Omega$ for R1 will ensure that the input bias current error of the adjust pin will be negligible. Do not bypass R1 or R2. This will lead to instabilities.

* Required if regulator is located far from power supply filter.

** C_O must be at least 22µF to maintain stability. May be increased without bound to maintain regulation during transients. Locate as close as possible to the regulator. This capacitor must be rated over the same operating temperature range as the regulator and the ESR is critical; see curve.

Figure 18. 5V to 20V Adjustable Regulator



*** To assure shutdown, select Resistor R3 to ensure at least 300µA of pull-up current when S1 is open. (Assume 2V at the ON/OFF pin.)

Figure 19. 1A Switch

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TEXAS INSTRUMENTS

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REVISION HISTORY SECTION

Released	Revision	Section	Changes
08/25/09	A	New Release, Corporate format	1 MDS data sheet converted into one Corp. data sheet format. Added Radiation products to ordering table. MNLM2941-X Rev 4A1 will be archived.
12–Oct-2011	В	Ordering Information, Absolute Max Ratings	Ordering Information — Added LM2941GW/883, LM2941GW-QMLV and LM2941GWRLQMLV. Absolute Max — Added Theta JA and Theta JC along with Package weight of 'GW' devices. RatingsLM2941QML Rev A will be archived.

REVISION HISTORY

CI	nanges from Revision A (April 2013) to Revision B	Page
•	Changed layout of National Data Sheet to TI format	9



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
5962-9166703QYA	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GW /883 Q 5962-91667 03QYA ACO 03QYA >T	Samples
5962-9166703VYA	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GW- QMLV Q 5962-91667 03VYA ACO 03VYA >T	Samples
5962R9166702V9A	ACTIVE	DIESALE	Y	0	34	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-55 to 125		Samples
5962R9166704VYA	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GWRL QMLV Q 5962R91667 04VYA ACO 04VYA >T	Samples
LM2941 MDE	ACTIVE	DIESALE	Y	0	34	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-55 to 125		Samples
LM2941-MD8	ACTIVE	DIESALE	Y	0	221	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM			Samples
LM2941GW-QMLV	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GW- QMLV Q 5962-91667 03VYA ACO 03VYA >T	Samples
LM2941GW/883	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GW /883 Q 5962-91667 03QYA ACO 03QYA >T	Samples
LM2941GWRLQMLV	ACTIVE	CFP	NAC	16	42	TBD	Call TI	Call TI	-55 to 125	LM2941GWRL QMLV Q 5962R91667 04VYA ACO 04VYA >T	Samples



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(1) The marketing status values are defined as follows:
 ACTIVE: Product device recommended for new designs.
 LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
 NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
 PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
 OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF LM2941QML, LM2941QML-SP :

Military: LM2941QML

• Space: LM2941QML-SP

PACKAGE OPTION ADDENDUM



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NOTE: Qualified Version Definitions:

- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

NAC0016A





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